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# N-Channel PowerTrench<sup>®</sup> MOSFET 30 V, 5.0 m $\Omega$

### Features

- Max  $r_{DS(on)} = 5.0 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 19 \text{ A}$
- Max  $r_{DS(on)} = 6.9 \text{ m}\Omega$  at  $V_{GS} = 4.5 \text{ V}$ ,  $I_D = 15 \text{ A}$
- Advanced Package and Silicon design for low r<sub>DS(on)</sub> and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery. Provides Schottky-like performance with minimum EMI in sync buck converter applications
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

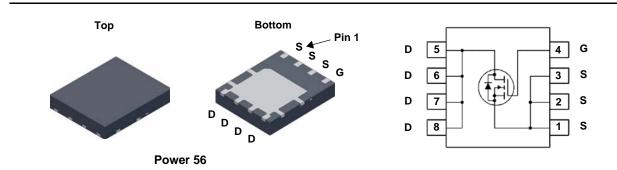


## **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low r<sub>DS(on)</sub>, fast switching speed and body diode reverse recovery performance.

### Applications

- IMVP Vcore Switching for Notebook
- VRM Vcore Switching for Desktop and Server
- OringFET / Load Switch
- DC-DC Conversion



## MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			30	V	
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V	
ID	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		28	A	
	-Continuous (Silicon limited)	T <sub>C</sub> = 25 °C		80		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	19	A	
	-Pulsed			90		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	72	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		48	W	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

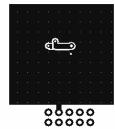
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		2.6	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/VV

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7672	FDMS7672	Power 56	13 "	12 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		15		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
	cteristics	.63 _0 ., .03 0				
	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.25	2.0	3.0	V
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{\rm GS} = V_{\rm DS}, I_{\rm D} = 230 \mu \Lambda$	1.25	2.0	5.0	v
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		-7		mV/°C
	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 19 A		3.6	5.0	-
r <sub>DS(on)</sub>		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A		5.2	6.9	mΩ
		$V_{GS}$ = 10 V, $I_{D}$ = 19 A, $T_{J}$ = 125 °C		4.9	6.8	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 19 A		64		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			2225	2960	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		685	910	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	T = 1 MHZ		90	130	pF
R <sub>q</sub>	Gate Resistance			0.7	1.5	Ω
-0	Characteristics	· · · · · ·		L	L	
t <sub>d(on)</sub>	Turn-On Delay Time			13	23	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 19 A,		5	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		25	40	ns
t <sub>f</sub>	Fall Time	1		4	10	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		31	44	nC
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 15 \text{ V},$		14	19	nC
Q <sub>gs</sub>	Gate to Source Charge	$I_{\rm D} = 19$ A		7.6		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			3.7		nC
×	Irce Diode Characteristics					
		$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.7	0.95	
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 19 \text{ A}$ (Note 2)		0.8	1.1	V
t <sub>rr</sub>	Reverse Recovery Time			32	51	ns
Q <sub>rr</sub>	Reverse Recovery Charge	1		14	24	nC
t <sub>a</sub>	Reverse Recovery Fall Time	I <sub>F</sub> = 19 A, di/dt = 100 A/μs		15		nC
t <sub>b</sub>	Reverse Recovery Rise Time			17		nC
S	Softness (t <sub>b</sub> /t <sub>a</sub> )	4		1.1		-
t <sub>rr</sub>	Reverse Recovery Time			26	42	ns
11	Reverse Recovery Charge	I <sub>F</sub> = 19 A, di/dt = 300 A/μs		25	40	nC

the user's board design.



a. 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.



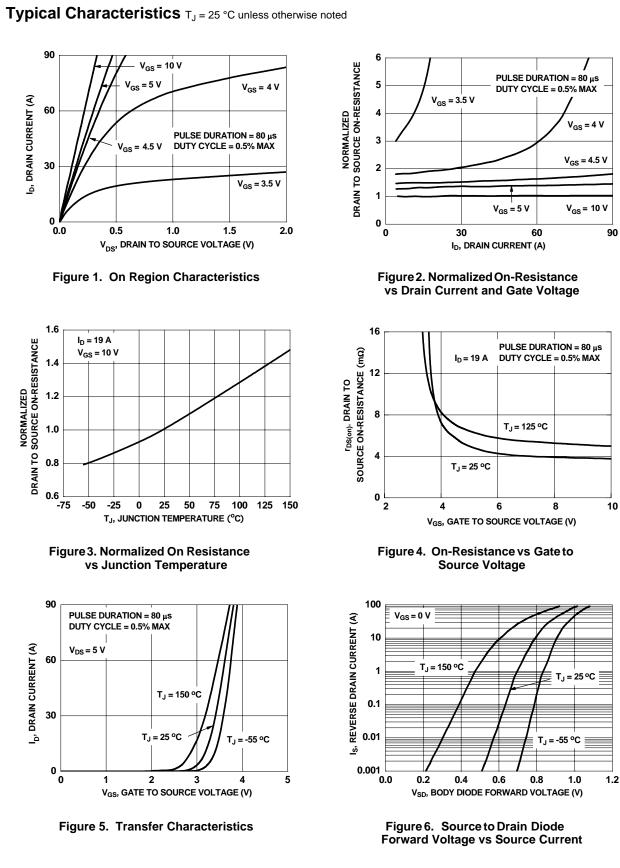
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

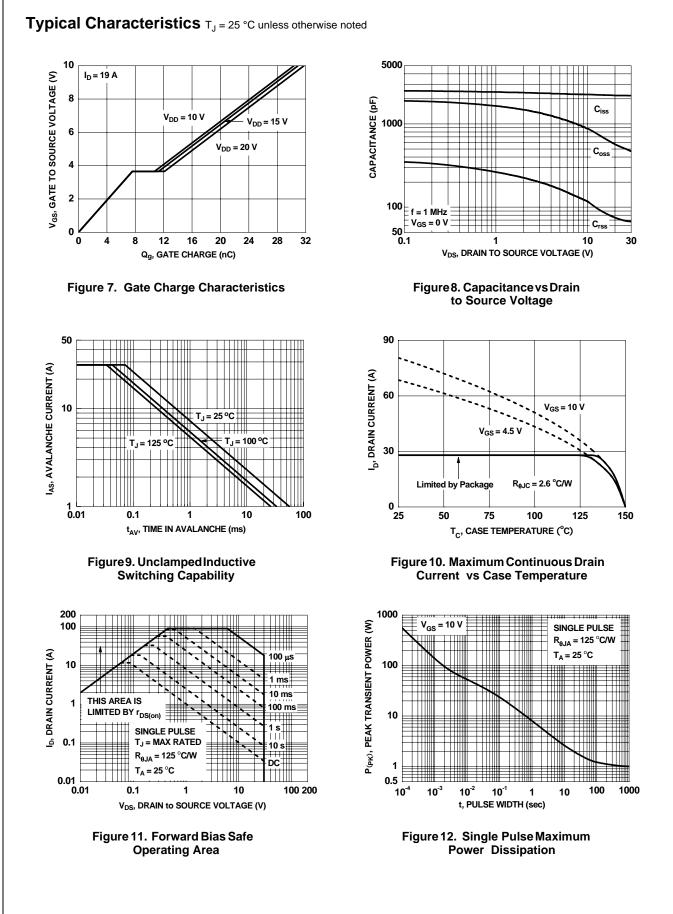
2. Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%.

3.  $E_{AS}$  of 72 mJ is based on starting  $T_J$  = 25 °C, L = 1 mH,  $I_{AS}$  = 12 A,  $V_{DD}$  = 27 V,  $V_{GS}$  = 10 V. 100% test at L = 0.3 mH,  $I_{AS}$  = 17 A.

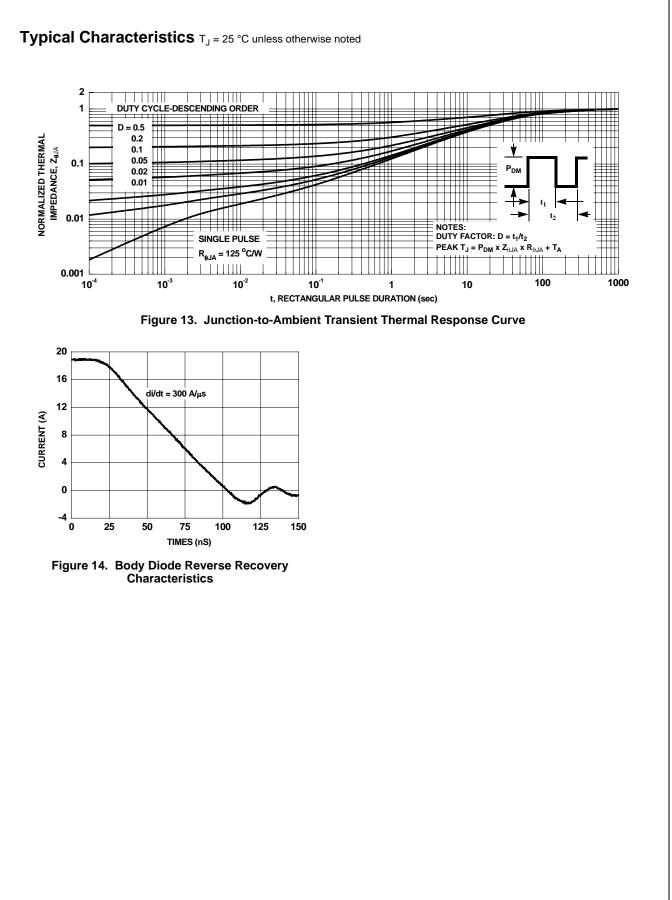
4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied. 2

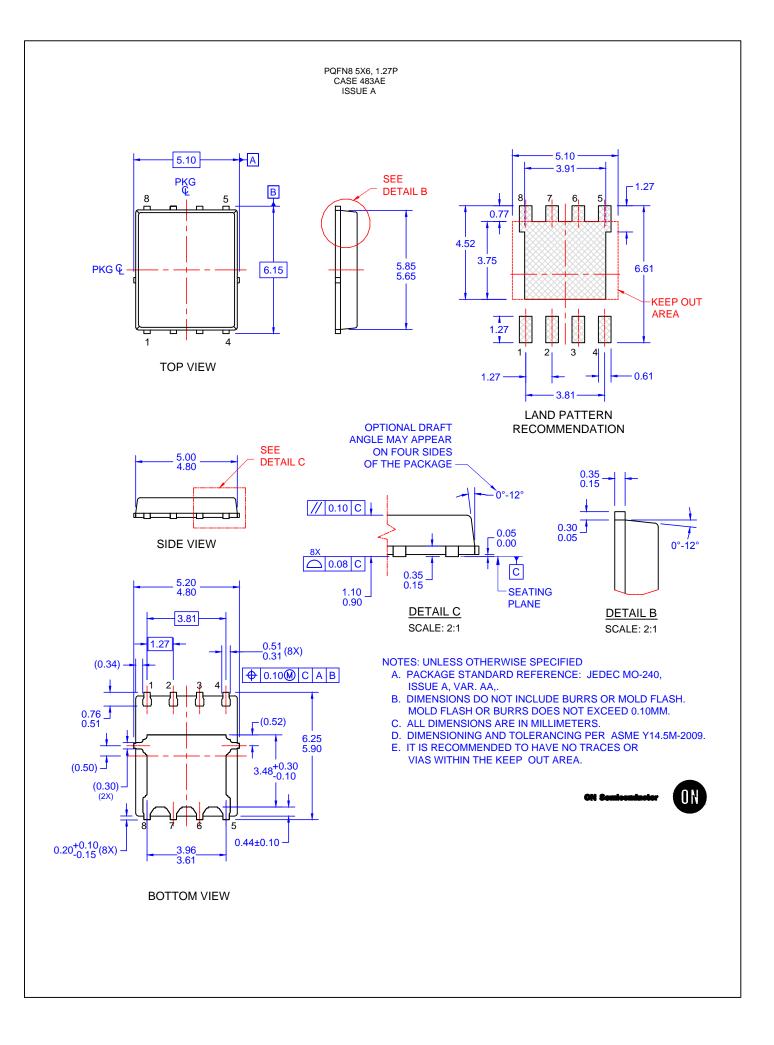
FDMS7672 N-Channel PowerTrench<sup>®</sup> MOSFET





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